

TLE4959-5U-SP Transmission Speed Sensor



Features

- Hall based differential speed sensor
- High magnetic sensitivity
- Large operating airgap
- Dynamic self-calibration principle
- Adaptive hysteresis
- High vibration suppression capabilities
- Three wire voltage interface
- Magnetic encoder and ferromagnetic wheel application
- High immunity against ESD, EMC and mechanical stress, improved voltage dropout capability
- Automotive operating temperature range
- 4-pin package PG-SSO-4-1
- Green Product (RoHS compliant)
- AEC Qualified

Applications

The TLE4959-5U-SP is an integrated differential Hall speed sensor ideally suited for transmission applications. Its basic function is to provide information about rotational speed and direction of rotation to the transmission control unit. TLE4959-5U-SP includes a sophisticated algorithm which actively suppresses vibration while keeping excellent airgap performance.

Table 1 Description

Туре	Marking	Ordering Code	Package
TLE4959-5U-SP	59AYA2	SP004842810	PG-SSO-4-1



Description

The TLE4959-5U-SP comes in a RoHs compliant four-pin package, qualified for automotive usage. the recommended capacitors increase the EMC robustness of the device. In 12 V applications it is further recommended to use a serial resistor R_{supply} for protection on the supply line. A pull-up resistor R_{Load} is mandatory on the output pin and determines the maximum current flowing through the output transistor. A value of 1.2 k Ω is recommended for the 5V application. (see Figure 1)

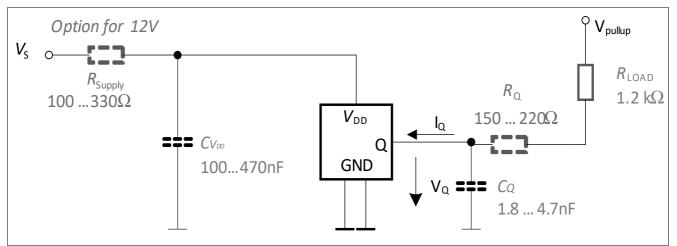


Figure 1 Typical Application Circuit



Functional Description

1 Functional Description

The differential Hall sensor IC detects the motion of tooth and magnet encoder applications. To detect the motion of ferromagnetic objects, the magnetic field must be provided by a back biasing permanent magnet. Either south or north pole of the magnet can be attached to the rear unmarked side of the IC package (See **Figure 2**). The magnetic measurement is based on three equally spaced Hall elements, integrated on the IC. Both magnetic and mechanical offsets are cancelled by a self calibration algorithm.

1.1 Definition of the Magnetic Field Direction

The magnetic field of a permanent magnet exits from the north pole and enters the south pole. If a north pole is attached to the backside of the High End Transmission Sensor, the field at the sensor position is positive, as shown in **Figure 2**.

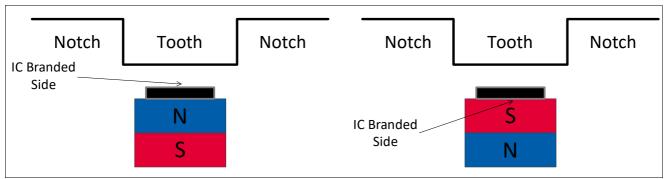


Figure 2 Definition of the Positive Magnetic Field Direction

1.2 Block Diagram

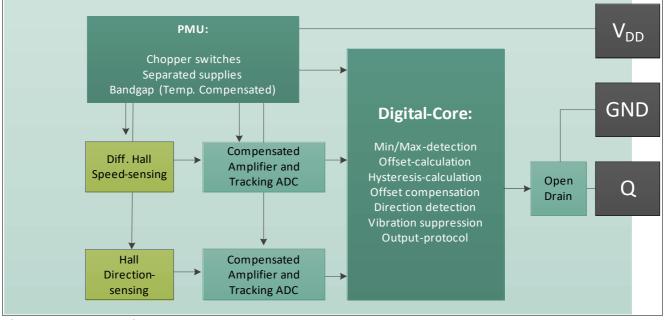


Figure 3 Block Diagram



Functional Description

1.3 Basic Operation

The speed signal calculated out of the differential hall elements, is amplified, filtered and digitized. An algorithm in the digital core for peak detection and offset calculation will be executed. The offset is fed back into the speed signal path with a digital to analog converter for offset correction. During uncalibrated mode, the output of the speed pulse is triggered in the digital core by exceeding a certain threshold of the tracking ADC. In calibrated mode the output is triggered by the visible hysteresis.

The direction signal is calculated out of center Hall signals. The direction signal is amplified, filtered, and digitized. In the digital core the direction and the vibration detection information is determined and the output protocol is issued.

1.4 Uncalibrated and Calibrated Mode

After power on the differential magnetic speed signal is tracked by an analog to digital converter (Tracking ADC) and monitored within the digital core. If the signal slope is identified as a rising edge or falling edge, the first output pulse is triggered. A second trigger pulse is issued with direction information.

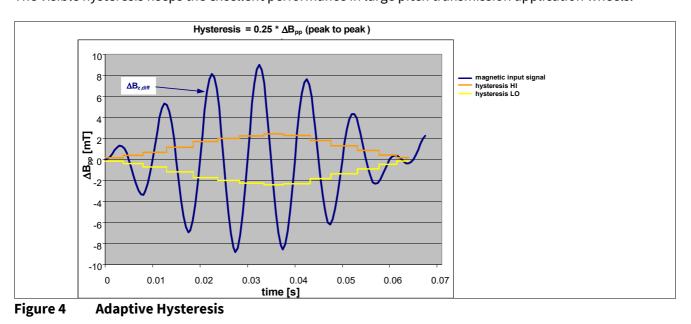
In uncalibrated mode, the output protocols are triggered by the DNC (detection noise constant) in the speed path. After start up the sensor switches with the DNC min value and after that the DNC is adapted to the magnetic input signal amplitude.

The offset update starts if two valid extrema values are found and the direction of the update has the same orientation as the magnetic signal. For example, a positive offset update is being issued on a rising magnetic edge only. After a successful offset correction, the sensor is in calibrated mode. Switching occurs at the adaptive hysteresis threshold level.

In calibrated mode, the DNC is adapted to magnetic input signal amplitude with a minimum of ΔB_{limit} . The output pulses are then triggered with adaptive hysteresis.

1.5 Hysteresis Concept

The adaptive hysteresis is linked to the input signal. Therefore, the system is able to suppress switching if vibration or noise signals are smaller than the adaptive hysteresis levels. The typical value for the hysteresis level is 1/4 of the magnetic input signal amplitude, the minimum hysteresis level is ΔB_{limit} . The visible hysteresis keeps the excellent performance in large pitch transmission application wheels.







Functional Description

1.6 Vibration Suppression

The direction signal is digitized by an analog to digital converter (direction ADC) and fed into the digital core. Depending upon the rotation direction of the target wheel, the signal of the center probe anticipates or lags behind for 90°. This phase relationship is evaluated and converted into rotation direction information by sampling the signal of the center probe in the proximity of the zero crossing of the "speed" bridge signal. The first pulse after power has a different length to signalize that there is no direction information available. The magnetic signal amplitude and the direction information are used for detection of parasitic magnetic signals. Unwanted magnetic signal can be caused by angular or air gap vibrations. If an input signal is identified as a vibration the output pulse will be suppressed.



General Characteristics

2 General Characteristics

2.1 Absolute Maximum Ratings

Table 2Absolute Maximum Ratings

Parameter	Symbol	Values			Unit	Note or Test Condition	
		Min.	Тур.	Max.			
Supply voltage without	V _{DD}	-16	-	18	V	continuous, $T_{\rm J} \le 175^{\circ}{\rm C}$	
supply resistor				27	V	max. 60 s, $T_{\rm J} \le 175^{\circ} \rm C$	
		-18			V	max. 60 s, $T_{\rm J} \le 175^{\circ}{\rm C}$	
Output OFF voltage	V _{Q_OFF}	-1.0	-		V	max. 1 h, $T_{Amb} \le 40^{\circ}C$	
		-0.3	-	26.5	V	continuous, T _J ≤175°C	
Output ON voltage	V _{Q_ON}	_	-	16	V	continuous, T _{Amb} ≤ 40°C	
		_	-	18	V	max. 1 h, $T_{Amb} \le 40^{\circ}C$	
		_	-	26.5	V	max. 60 s, $T_{Amb} \le 40^{\circ}C$	
Junction temperature range	TJ	-40	-	185	°C	exposure time: max. 10×1 h, $V_{DD} = 16V$	
Magnetic field induction	B _Z	-5	-	5	Т	magnetic pulse during magnet magnetization. Valid 10 s with T _{ambient} ≤ 80°C	
ESD compliance	ESD _{HBM}	-2	-	2	kV	HBM ¹⁾	

1) ESD susceptibility, HBM according to EIA/JESD 22-A114B

Note: Stresses above the max values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.



General Characteristics

2.2 Operating Range

All parameters specified in the following sections refer to these operating conditions unless otherwise specified.

Table 3General Operating Conditions

Parameter	Symbol		Value	S	Unit	Note or Test Condition	
		Min. Typ. M		Max.	1		
Supply voltage without supply resistance R _s	V _{DD}	4.0	-	16	V		
Continuous Output Off voltage	V _{Q_OFF}	-	-	16	V		
Supply voltage power- up/down voltage ramp	<i>dV</i> _{DD} /dt	3.0	-	1e4	V/ms		
Supply current	I _{DD}	8.0	-	13.4	mA		
Continuous output On current	I _{Q_ON}		-	15	mA	V _{Q_LOW} < 0.5 V	
Magnetic signal frequency range	f	0	-	10	kHz		
Dynamic range of the magnetic field of the differential speed channel	DR _{mag_field_s}	-120	-	120	mT		
Dynamic range of the magnetic field of the direction channel	DR _{mag_field_dir}	-60	-	60	mT		
Static range of the magnetic field of the outer Hall probes	SR _{mag_field_s}	0	-	550	mT		
Static range of the magnetic field of the center Hall probe	DR _{mag_field_dir}	-100	-	450	mT		
Allowed static difference between outer probes	SR _{mag_field_diff}	-30	-	30	mT		
Normal operating junction temperature	T _J	-40	-	175	°C	exposure time: max. 2500 h at <i>T</i> J = 175°C, <i>V</i> DD = 16 V	
		-	-	185	°C	exposure time: max. 10 × 1 h at T_J = 185°C, V_{DD} = 16 V, additive to othe lifetime	
Not operational lifetime	T _{no}	-40		150	°C	without sensor function; exposure time max 500 h @ 150°C; increased time for lower temperatures according to Arrhenius- Model, additive to other lifetime	
Temperature compensation range of magnetic material	ТС		-800		ppm	internal compensation of magnetic signal amplitude of speed signal	

Note: In the operating range the functions given in the functional description are fulfilled



Electrical and Magnetic Characteristics

3 Electrical and Magnetic Characteristics

All values specified at constant amplitude and offset of input signal, over operating range, unless otherwise specified. Typical values correspond to $V_s = 5 V$ and $T_{Amb.} = 25^{\circ}C$

Table 4	Electrical and Magnetic Parameters
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Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
Output saturation voltage	V _{Qsat}	0	-	500	mV	l _Q ≤ 15 mA
Clamping voltage V _{DD} -Pin	$V_{\rm DD_clamp}$	42		-	V	leakage current through ESD diode < 0.5mA
Clamping voltage V _Q -Pin	V _{Qclamp}	42		-	V	leakage current through ESD diode < 0.5mA
Reset voltage	V _{DD_reset}	2.8		3.6	V	
Output leakage current	I _{Qleak}	0	0.1	10	μA	V _Q = 18 V
Output current limit during short-circuit condition	I _{Qshort}	30	-	80	mA	
Junction temperature limit for output protection	T _{prot}	190	-	205	°C	
Power on time	t _{power_on}	0.8	0.9	1	ms	during this time the output is locked to high.
Delay time between magnetic signal switching point and corresponding output signal falling edge switching event	t _{delay}	10	14	19	μs	
Output fall time	t _{fall}	2.0	2.5	3.0	μs	$V_{Pullup} = 5 V, R_{Pullup} = 1.2 kΩ (+, 10\%), C_Q = 1.8 nF (+/-15\%),$ valid between 80% - 20%
		3.2	4.5	5.8	μs	$V_{Pullup} = 5 V, R_{Pullup} = 1.2 kΩ (+, 10\%), C_Q = 1.8 nF (+/-15\%),$ valid between 90% - 10%
Output rise time	t _{rise} ¹⁾	4	-	11.4	μs	$R_{Pullup} = 1.2 \text{ k}\Omega (+/-10\%),$ $C_Q = 1.8 \text{ nF} (+/-15\%),$ valid between 10% - 90%
Digital noise constant of speed channel during start up	DNC _{min}	1.22	1.5	1.78	mT	
Duty Cycle in calibrated mode ²⁾	Dty	40		60	%	on sinusoidal signals
Period Jitter, $f \le 8 \text{ kHz}^{3}$	Jit _{8kHz}	-1	-	1	%	1 sigma, ΔB_{pkpk} = 3mT
Period Jitter, 8kHz $\leq f \leq 10$ kHz ²⁾	Jit _{10kHz}	-1.1		1.1	%	1 sigma, $\Delta B_{pkpk} = 3mT$
Number of wrong pulses at	n _{Start}	-	-	0	n	in forward rotational directio
start-up		0	-	1	n	in backward rotational direction



Electrical and Magnetic Characteristics

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
Global run out ⁴⁾	Runout _{glob}	0	-	40	%	of magnetic speed signal amplitude
		0	-	60	%	of magnetic speed signal amplitude with reduced performance on stop-start- functionality
	Runout _{glob} al,dir	0	-	40	%	of magnetic direction signa amplitude
		0	-	60	%	of magnetic direction signa amplitude with reduced performance on stop-start- functionality
Tooth to tooth run out (peak to peak variation on two consecutive teeth / pole-pair) ³⁾	Runout _{tooth}	0	-	40	%	of magnetic speed signal amplitude
	Runout _{tooth}	0	-	40	%	of magnetic direction signa amplitude

Table 4Electrical and Magnetic Parameters (cont'd)

1) Application parameter, IC shall not increase the rise time, Values are calculated and not tested

2) During fast offset alterations, due to the calibration algorithm, exceeding the specified duty cycle is permitted for short time periods. Parameter not subject to production test, verify by design/characterization.

 Parameter not subject to productive test. Verified by lab characterization based on jitter-measurement > 1000 periods

4) Defined as 1-(amplitude_min/amplitude_max)

Note: The listed Electrical and magnetic characteristics are ensured over the operating range of the integrated circuit. Typical characteristics specify mean values expected over the production spread. If not other specified, typical characteristics apply at $T_{Amb} = 25$ °C and $V_S = 5$ V.



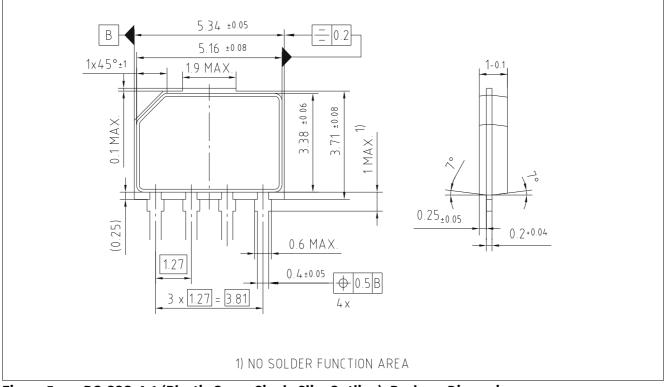
Package Information

4 Package Information

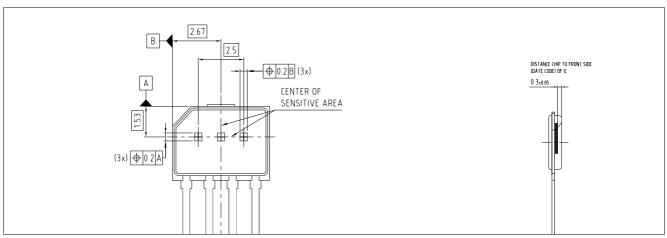
Pure tin covering (green lead plating) is used. The product is RoHS (Restriction of Hazardous Substances) compliant and marked with letter G in front of the data code marking and may contain a data matrix code on the rear side of the package (see also information note 136/03). Please refer to your key account team or regional sales if you need further information.

The specification for soldering and welding is defined in the latest revision of application note "Recommendation for Board Assembly-Hallsensor SSO Packages".

4.1 Package Outline











Package Information

4.2 Marking and Data Matrix Code

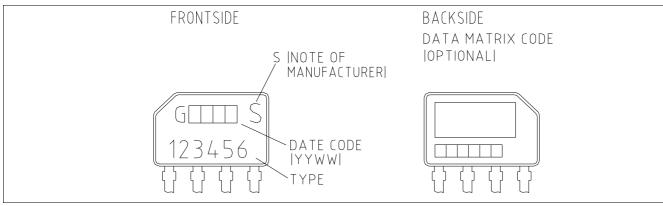


Figure 7 Marking of PG-SSO-4-1 Package

Table 5 Pin Description

Pin Number ¹⁾	Symbol	Function		
1	V _{DD}	Supply Voltage		
2	GND	Ground		
3	GND	Ground		
4 Q		Open Drain Output		

1) Refer to frontside view: leftmost pin corresponding to pin number 1



Package Information

4.3 Packing Information

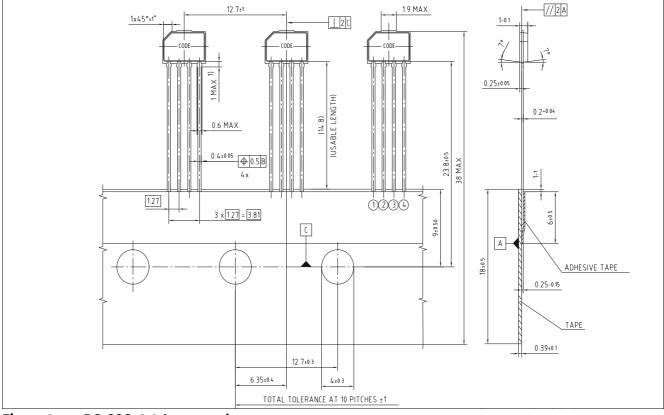


Figure 8 PG-SSO-4-1 Ammopack



Revision History

5 Revision History

Version	Date	Changes
1.0	2019-07	First version of released datasheet

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